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Unterpremstätten, June 2007

Product Change Notification Number: 02 - 2007
Change of procedures for internal visual test methods

Dear Customer,

Please be informed, that austriamicrosystems AG will change the Quality control gate at Fab out (optical inspection of wafers) from a manual microscope inspection to an automated visual inspection performed by a high end fully automated inspection tool.

Products affected:

All wafers produced at austriamicrosystems Fab B

Change purpose:

As part of our continuous improvement process and as integrated part of our "Zero Defects program" we are steady working on enhanced quality gates to detect any abnormality on our material and to guarantee fast and efficient feedback to our production line.

The cooperation with the market leader in the field of automated visual inspection "*Rudolph Technologies*" and the use of high end tools guarantee highest security in this field.

It enables us to replaces any other manual inspection for fab related defects with highest reliability.

Risk Assessment:

No risk

Timing of change (planned for your product): September 2007

Measurement qualification tests:

Run attribute gage R&R study

Impact on Product:

No impact on products

Enhance Quality level at optical inspection gate

Please be advised that unless we receive your written refusal concerning this PCN within 30 days, the PCN shall be deemed accepted.

For further information please feel free to contact me.

Best regards,

austriamicrosystems AG

A handwritten signature in black ink, appearing to read 'Theißl Udo', written in a cursive style.

Udo Theißl

Manager Quality Control